

Data sheet acquired from Harris Semiconductor SCHS048C – Revised October 2003

CMOS Liquid-Crystal Display Drivers

High-Voltage Types (20-Volt Rating)

CD4054B - 4-Segment Display Driver

CD4055B — BCD to 7-Segment Decoder/Driver with "Display-Frequency" Output

CD4056B — BCD to 7-Segment Decoder/Driver with Strobed-Latch Function

single-digit BCD-to-7-segment decoder/driver circuits that provide level-shifting functions on the chip. This feature permits the BCD input-signal swings (VDD to VSS) to be the same as or different from the 7-segment output-signal swings (VDD to VEE). For example, the BCD input-signal swings (VDD to VSS) may be as small as 0 to -3 V, whereas the output-display drive-signal swing (VDD to VEE) may be as large as from 0 to -15V. If VDD to VEE exceeds 15 V, VDD to VSS should be at least 4V (0 to -4V).

The 7-segment outputs are controlled by the DISPLAY-FREQUENCY (DF) input which causes the selected segment outputs to be low, high, or a square-wave output (for liquid-crystal displays). When the DF input is low the output segments will be high when selected by the BCD inputs. When the DF input is high, the output segments will be low when selected by the BCD inputs. When a square-wave is present at the DF input, the selected segments will have a square-wave output that is 180° out of phase with the DF input. Those segments which are not selected will have a squarewave output that is in phase with the input. DF square-wave repetition rates for liquidcrystal displays usually range from 30 Hz (well above flicker rate) to 200 Hz (well below the upper limit of the liquid-crystal frequency response). The CD4055B provides a level-shifted high-amplitude DF output which is required for driving the common electrode in liquid-crystal displays. The CD4056B provides a strobed-latch function at the BCD inputs. Decoding of all input combinations on the CD4055B and CD4056B provides displays of 0 to 9 as well as L. P. H, A, -, and a blank position.

The CD4054B provides level shifting similar to the CD4055B and CD4056B independently strobed latches, and common DF control on 4 signal lines. The CD4054B is intended to provide drive-signal compatibility with the CD4055B and CD4056B 7-segment decoder types for the decimal point, colon, polarity, and similar display lines. A level-shifted high-amplitude DF output can be obtained from any CD4054B output line by connect-

CD4054B, CD4055B, CD4056B Types

Features:

- Operation of liquid crystals with CMOS circuits provides ultra-low-power displays
- Equivalent ac output drive for liquidcrystal displays — no external capacitor required
- Voltage doubling across display, e.g.
 VDD VEE = 18 V results in effective
 36 V p-p drive across selected display segments
- Low- or high-output level dc drive for other types of displays
- On-chip logic-level conversion for different input- and output-level swings
- Full decoding of all input combinations:
 0-9, L, H, P, A,-, and blank positions
- Strobed-latch function—CD4054B Series and CD4056B Series
- DISPLAY-FREQUENCY (DF) output for liquid-crystal common-line drive signal— CD4055B Series (CD4054B Series also: see introductory text)
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package temperature range):

1 V at V_{DD} = 5 V 2 V at V_{DD} = 10 V 2.5 V at V_{DD} = 15 V

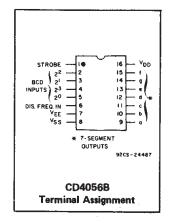
■ 5-V, 10-V, and 15-V parametric ratings

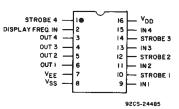
Applications

- General-purpose displays
- Calculators and meters
- Wall and table clocks
- Industrial control panels
- Portable lab instruments
- Panel meters
- Auto dashboard displays
- Appliance control panels

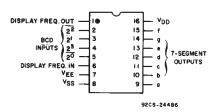
ing the corresponding input and strobe lines to a low and high level, respectively and applying a square wave to DFIN. The CD4054B may also be utilized for logic-level "up conversion" or "down conversion". For example, input-signal swings (VDD to VSS) from +5 to 0 V can be converted to outputsignal swings (VDD to VEE) of +5 to -5 V. The level-shifted function on all three types permits the use of different input- and output-signal swings. The input swings from a low level of VSS to a high level of VDD while the output swings from a low level of VEE to the same high level of VDD. Thus, the input and output swings can be selected independently of each other over a 3-to-18 V range. VSS may be connected to VEE when no level-shift function is required.

For the CD4054B and CD4056B, data are





CD4054B Terminal Assignment

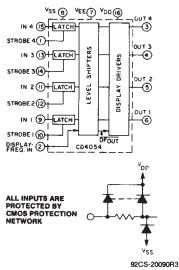


CD40558 Terminal Assignment

transferred from input to output by placing a high voltage level at the strobe input. A low voltage level at the strobe input latches the data input and the corresponding output segments remain selected (or non-selected) while the strobe is low.

Whenever the level-shifting function is required, the CD4055B can be used by itself to drive a liquid-crystal display (Fig.16 and Fig.20). The CD4056B, however, must be used together with a CD4054B to provide the common DF output (Fig.19). The capability of extending the voltage swing on the negative end (this voltage cannot be extended on the positive end) can be used to advantage in the setup of Fig.18. Fig.17 is common to all three types.

The CD4054B-, CD4055B-, and CD4056B-series types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4054B- and CD4056B-series types also are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix).



90 (O) -(12) d -(15) VDD ALL INPUTS ARE PROTECTED BY CMOS PROTECTION NETWORK 92CS-20092R2

Fig.1 - CD4054B functional diagram.

Fig.2 - CD4055B functional diagram.

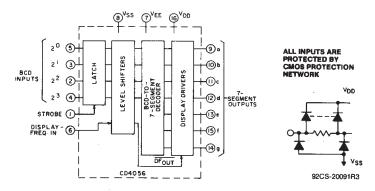


Fig.3 - CD4056B functional diagram.

CD4054B TRUTH TABLE

DF	IN	ST	OUT
0	0	1	0
1	0	1	1
0	1	1	1
1	1	1	0
Х	Х	0	•

X = Don't Care.

*Depends upon the input mode previously applied when ST = 1.

TRUTH TABLE FOR CD4055B and CD4056B

- 11	NPU"	r co	DE			OUTF	UT S	TAT	E	- 1		DISPLAY CHARAC-
23	22	21	20	а	ь	C	d	е	f	g		TER
0	0	0	0	1	1	1	1	1	1	0		i
0	0	0	1	0	1	1	0	0	0	0		
0	0	1	0	1	1	0	1	1	0	1		<u>,=</u> '
0	0	1	1	1	1	1	1	0	0	1		=
0	1	0	0	0	1	1	0	0	1	1		1—;
0	1	0	1	1	0	1	1	0	1	1	П	<u>'</u>
0	1	1	0	1	0	1	1	1	1	1	\prod	<u> =</u> ,
0	1	1	1	1	1	1	0	0	0	0		
1	0	0	0	1	1	1	1	1	1	1	$\ $	
1	0	0	1	1	1	1	1	0	1	1		'='
1	0	1	0	0	0	0	1	1	1	0		1
1	0	1	1	0	1	1	0	1	1	1	I	
1	1	0	0	1	1	0	0	1	1	1	\prod	
1	1	0	1	1	1	1	0	1	1	1		; = ;
1	1	1	0	0	0	0	0	0	0	1	$\ $	
1	1	1	1	0	0	0	0	0	0	0	\prod	BLANK

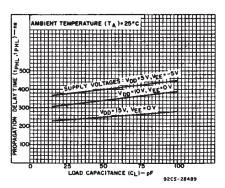


Fig.4 - Typical propagation delay time vs. load capacitance for CD4054B.

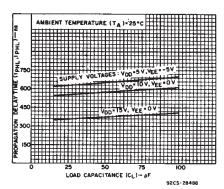


Fig.5 — Typical propagation delay time vs. load capacitance for CD4055 and CD4056B.

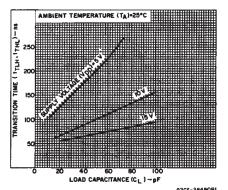


Fig.6 - Typical transition time vs. load capacitance.

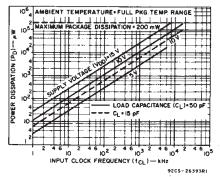


Fig.7 - Typical input clock frequency vs. power dissipation.

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (V _{DD})	
Voltages referenced to VSS Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$	500mW
For T _A = +100°C to +125°C	12mW/OC to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	100mW
OPERATING-TEMPERATURE RANGE (TA)	55°C to +125°C
STORAGE TEMPERATURE RANGE (T _{stg})	65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79mm) from case for 10s max	+265°C

MBIENT TEMPERATURE (TA)=25°C 5 IO I5 DRAIN-TO-SOURCE VOLTAGE (V_{DS})-V 92C9-35963

Fig.8 - Typical n-channel output low (sink) current characteristics.

NT TEMPERATURE (TA) - 25°C DRAIN-TO-SOUR E VOLTAGE (VDS)-V

Fig.9 - Minimum n-channel output low (sink) current characteristics.

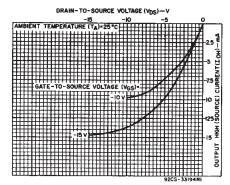


Fig. 10 - Typical p-channel output high (source) current characteristics.

DRAIN-TO-SOURCE VOLTAGE (VDS)-V

Fig. 13 — Minimum p-channel output high (source) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS

		_	NDIT	ONS		LIMIT	S AT II	NDICA.	TED TE	MPER	ATURE	s (°C)	
Characteristic	V _{EE}	V _{SS}	4	V _{IN}	V _{DD}	<u> </u>	<u> </u>		Ī —	T	+25°C		Units
				L		-55°	-40°	+850	+1250	Min.	Тур.	Max.	1
Quiescent Device	- 5	0			5		5	150	150	-	0.04	5	μА
Current, IDD	0	0			10		10	300	300		0.04	10	1 "
MAX.	0	0	ļ		15		20	600	600	_	0.04	20	1
	0	0	<u> </u>	L	20	1	00	3000	3000	. –	0.08	100	1
Output Voltage:													
	0	0	L	0,5	5		0.05				0	0.05	
Low Level, VOL	0	0	L	0,10	10		0	.05			0	0.05	1
MAX.	0	0		0,15	15		0	.05			0	0.05	1
	0	0		0,5	5		4.95				5	-	V
High Level, VOH	0	0		0,10	10		9	.95	-	9.95	10		1 1
MIN.	0	0	L	0,15	15		14.95				15		1 1
Input Low Voltage,	0	0	0.5, 4.5		5		1	.5		_	_	1.5	
VIL MAX.	0	0	1,9		10			3				3	
	0	0 1	.5,13.	5	15			4			1 -	4	
Input High	- 5	0	0.5,4.5		5		3	.5	-	3.5			V
Voltage,	0	0	1,9		10			7		7	-		
VIH MIN.	0	0 1	.5,13.5		15		1	11		11	-	-	
Output Low (Sink)	-5	0	-4.5		5	0.98	0.92	0.67	0.55	0.8	1.6		
Current, IOL	0	0	0.5		10	0.98	0.92	0.67	0.55	0.8	1.6	_	
	0	0	1.5		15	3.6	3.4	2.4	2	2.9	5.8		ŀ
Output High	-5	0	4.5		5	-0.6	0.55	0.35	0.3	-0.45	-0.9		mA
(Source)	0	0	9.5		10	-0.6	0.55	0.35	-0.3	-0.45	-0.9		
Current, IOH	0	Ó	13.5		15	-1.9	-1.8	-1.2	-1.1	- 1.5	-3		- 1
Input Current,	0	0	-	0,18	18	±0.1	±0.1	±1	±1	-	±10-5	±0.1	μΑ

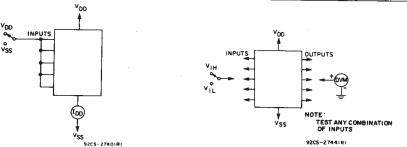


Fig. 11 - Quiescent-device-current test circuit.

Fig. 12 - Input-voltage test circuit.

DYNAMIC ELECTRICAL CHARACTERISTICS at TA = 25°C, CL = 50 pF, Input tr, tr = 20 ns, RL = 200 k Ω

	COI	NDITI				LIMITS	VDEC		
CHARACTERISTIC	VEE (V)	Vss (V)	V _{DD}		LL PA	CKAGE T	,CD4056	UNITS	
	(4)	()	(*/	Тур.	Max.	Тур.	Max.		
Propagation Delay Time,	– 5	0	5	400	800	650	1300		
tPHL,tPLH	0	0	10	340	680	575	1150	ns	
(Any Input to Any Output)	0 -	0	15	250	500	375	750		
Transition Time, t _{THL} ,t _{TLH}	-5	0	5	100	200	100	200	ns	
(Any Output)	0	0	10	100	200	100	200		
	0	0	15	75	150	75	150		
Minimum Data Setup	-5	0	5	110	220	110	220		
Time, to*	0	0	10	50	100	50	100	ns	
Time, ts			15	35	70	35	70		
Minimum Strobe Pulse	-5	0	5	110	220	110	220		
	0	0	10	50	100	50	100	ns	
Width, t _W *	0	0	15	35	70	35	70		
Input Capacitance, CIN (Any Input)	_	-	-	5	7.5	5	7.5	pF	

^{*} CD4054 and CD4056 only.

RECOMMENDED OPERATING CONDITIONS at T_A = 25°C (Unless otherwise specified)

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	VEE	VSS	V _{DD}	LIM	ITS	UNITS	
CHARACTERISTIC	(V)	(V)	(V)	Min.	Max.	OINI I 3	
Supply Voltage Range: (At TA = Full Package Temperature Range)				3	18	>	
	5	0	5	220	_		
Setup Time (t _c)●	0	0	10	100		ns	
	0	0	15	70	_		
	-5	-0	5	220			
Strobe Pulse Width (tw)	0	0	10	100		ns	
·	0	0	15	70	_	<u> </u>	

For CD4054 and CD4056 only.

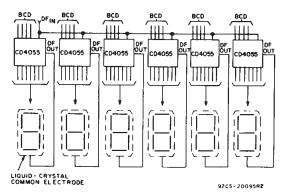


Fig. 16 - Clock display: V_{DD} = 0 V, V_{SS} =-5 V, V_{EE} = -15 V, DF_{IN} = 30 Hz square wave.

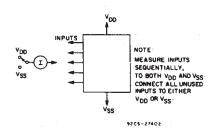


Fig. 14 - Input-current test circuit.

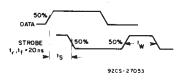
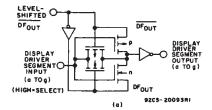


Fig. 15 — Data setup time and strobe pulse duration.



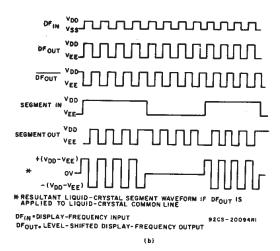


Fig. 17 — Display-driver circuit for one segment line and waveforms,

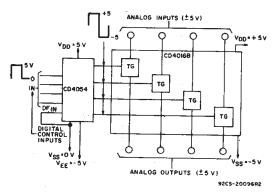


Fig. 18 - Digital (0 to +5 V) to bidirectional analog control (+5 to -5 V) level shifter.

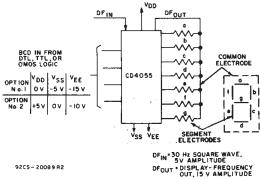


Fig.20 - Single-digit liquid-crystal display.

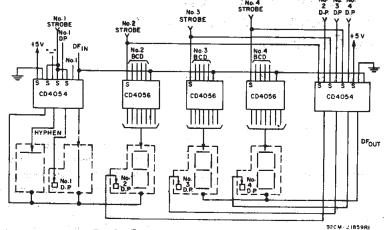


Fig. 19 — Typical 3½-digit liquid-crystal display: V_{DD} = +5 V, V_{SS} = 0 V, V_{EE} = -10 V, DF_{IN} = 30 Hz square wave.

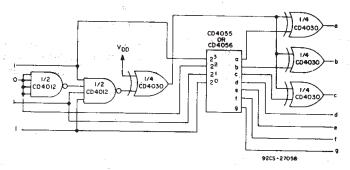


Fig.21 - Conversion of "H" display to "F" display.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated.

Grid graduations are in mils (10⁻³ inch),

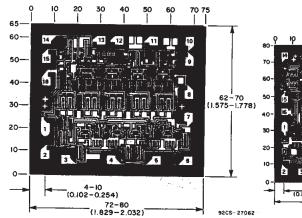
examp display

One of VEE=N

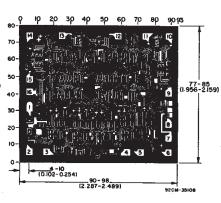
In addition to the letters L, H, P, and A (See the truth table), five other letters can be displayed through the use of simple logic circuits preceding and following the CD4055B or CD4056B devices. Fig.21 is an example of a circuit that converts an "H" display (code 1011) to an "F" display. One condition that must be met is that VEE=VSS. If VEE=VSS, the CD4054B must be used to level shift in the appropriate places.

In a similar manner the letters C, E, J, and U can be displayed. These circuits can also be used to drive LED displays provided the exclusive-OR gates have sufficient output-current drive.

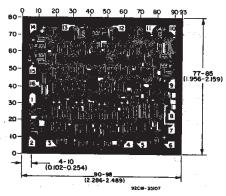
The letters B, D, G, I, O, and S may be represented by the codes for numbers 8, 0, 6, 1, 0, and 5, respectively, when there is preknowledge that only letters are to be displayed.



Dimensions and pad layout for CD4054BH.



Dimensions and pad layout for CD4055BH



Dimensions and pad layout for CD4056BH

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
CD4054BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4054BE
CD4054BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4054BE
CD4054BF3A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD4054BF3A
CD4054BF3A.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD4054BF3A
CD4054BM	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-55 to 125	CD4054BM
CD4054BM96	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4054BM
CD4054BM96.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4054BM
CD4054BPW	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM054B
CD4054BPW.A	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM054B
CD4055BE	Last Time Buy	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4055BE
CD4055BM	Last Time Buy	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4055BM
CD4055BPW	Last Time Buy	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM055B
CD4056BE	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4056BE
CD4056BE.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	-55 to 125	CD4056BE
CD4056BF3A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD4056BF3A
CD4056BF3A.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	CD4056BF3A
CD4056BM	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-55 to 125	CD4056BM
CD4056BM96	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4056BM
CD4056BM96.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CD4056BM
CD4056BMT	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-55 to 125	CD4056BM
CD4056BPW	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM056B
CD4056BPW.A	Active	Production	TSSOP (PW) 16	90 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	CM056B

⁽¹⁾ Status: For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

PACKAGE OPTION ADDENDUM

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- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF CD4054B, CD4054B-MIL, CD4056B, CD4056B-MIL:

Catalog : CD4054B, CD4056B

Military: CD4054B-MIL, CD4056B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4054BM96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
CD4056BM96	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1



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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4054BM96	SOIC	D	16	2500	340.5	336.1	32.0
CD4056BM96	SOIC	D	16	2500	340.5	336.1	32.0



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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
CD4054BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4054BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4054BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4054BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4054BPW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4054BPW.A	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4055BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4055BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4055BM	D	SOIC	16	40	507	8	3940	4.32
CD4055BPW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4056BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4056BE	N	PDIP	16	25	506	13.97	11230	4.32
CD4056BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4056BE.A	N	PDIP	16	25	506	13.97	11230	4.32
CD4056BPW	PW	TSSOP	16	90	530	10.2	3600	3.5
CD4056BPW.A	PW	TSSOP	16	90	530	10.2	3600	3.5

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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